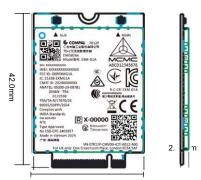


Compal Electronics EXM-G1A Embedded Modules

Advanced LTE Data Module

Enabling a new generation of the art data cards featuring with LTE, WCDMA and GNSS support for the following applications: High Power Fixed Wireless Access, enterprise routers and gateways, indoor/outdoor CPE, video broadcasting and surveillance.



30.0mm

Compact, Powerful, Hostless and Highly integrated Proof LTE Modules

Compal EXM-G1A is a series of LTE communication modules for Worldwide EU broadband Market, which support LTE network architectures with faster transmission speed, better carrying capacity, and lower network latency.

EXM-G1A Module supports LTE and WCDMA standards, eliminating customers' investment concerns in the initial stage of LTE construction and responding to the commercial demand of rapid landing.

This WWAN card follows the PCIe association standard for pin definitions and supports commonly found interfaces on M.2 cards such as USB 2.0/3.0, I2C, MIPI, and GPIO. Its abundant functionalities, including USB drivers for Windows 7/8/8.1/10, Linux, and Android, extend the module's applicability to IoT and M2M applications, such as business routers, industrial laptops, consumer laptops, industrial PDAs, and rugged tablet PCs.

Key Benefits

- Quad Cortex-A7 application processor 1.28GHz
- 4G LTE FDD and TDD and WCDMA
- LTE R12 Cat.12
 - 600Mbps DL 3CC, 2x2 MIMO
 - 150 Mbps UL 2CC
 - DL 256QAM / UL 64QAM
- Driver support for Linux, Windows

EXM-G1A	
FORM FACTOR	M.2
FREQUENCY BANDS	
LTE	LTE FDD: B1, B2, B3, B4, B5, B7, B8, B12, B13, B14, B18, B19, B20, B25, B26, B28, B29, B32, B66, B71 LTE TDD: B38, B39, B40, B41, B42, B43, B48
WCDMA	B1, B2, B4, B5, B6, B8, B9, B19
Simultaneous GPS	L1, GLONASS(GLO), Galileo(GAL), BeiDou(BDS) and QZSS
DL 2x2 MIMO	LTE FDD: B1, B2, B3, B4, B5, B7, B8, B12, B13, B14, B18, B19, B20, B25, B26, B28, B29, B32, B66, B71 LTE TDD: B38, B39, B40, B41, B42, B43, B48
INTERFACE	
Antenna Port	x 2 Support 2x2 MIMO
Tunable antenna	MIPI x 1
USB	USB 2.0 HS/3.0/3.1 SS Gen1:
GPIO	General-Purpose I/O x 3pin RF Antenna control x 4pin
I2C	I2C_CLK/ I2C_DATA/ I2C_IRQ# Reserved
SIM interface 1.8V/3V	Dual USIM 2.85V/1.8V (One embedded eSIM and USIM1 interface)
LED Indicate Control Pin	ISINK x 1 (up to 12 mA)
Key	Power On, Reset
Protocol Stack	IPV4/IPV6
Firmware update	FOTA
DRIVERS	Windows 10/11, Linux, Chrome
AT commands	3GPP TS 27.007
Dimensions	42.0mm × 30.0mm × 2.30mm
Temperature	
Operating temperature	-30°C ~+70°C
Extended temperature	-40°C ~+85°C
Support Voltage	
Power Supply Voltage	3.135~4.4V (Typical:3.3V)
APPROVALS	
RoHS Compliant	Υ

VISIT US: https://www.compal.com

Email: Compal_5G@Compal.com

Tel: +886-2-87516228

 * appear on this brochure are the property of the respective owners. © 2021 COMPAL ELECTRONICS, Inc. 2021.05.26

Copyright © 2021 COMPAL ELECTRONICS, INC. All rights reserved.

Without the prior written permission of the copyright holder, any company or individual is prohibited to excerpt, copy any part of or the entire document, or distribute the document in any form.

